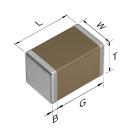
积层贴片陶瓷片式电容器

C2012JB2A152M085AA

RoHS Reach Halogen Free Pb Free

交货型号	C2012JB2A152MT****	
用途	一般等级	
特点	Mid 中耐压(100~630V)	
系列	C2012 [EIA 0805]	
状态	▲ 量产体制(新设计非推荐)	



尺寸			
长度(L)	2.00 mm ± 0.20 mm		
宽度(W)	1.25 mm ± 0.20 mm		
厚度(T)	0.85 mm ± 0.15 mm		
端子宽度(B)	0.20mm Min.		
端子间隔(G)	0.50mm Min.		
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)		
1世存/杆益41/可 (FA)	0.90mm to 1.20mm(Reflow Soldering)		
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)		
推存序益利内(FD)	0.70mm to 0.90mm(Reflow Soldering)		
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)		
7世代/平流41/円(10/	0.90mm to 1.20mm(Reflow Soldering)		

电·	气特性
电容	1.5nF ±20%
额定电压	100VDC
温度特性	JB(±10%)
耗散因数(Max.)	3%
绝缘电阻 (Min.)	10000ΜΩ

	其他	
焊接方法	流体	
坪 接刀法	回流	
AEC-Q200	NO NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

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特性图表(这是参考数据,并不保证产品的特性。)

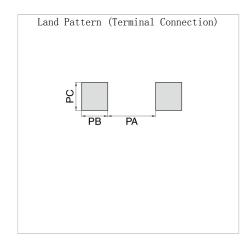
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Associated Images



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